

Welcome to E-XFL.COM

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details	
Product Status	Not For New Designs
Core Processor	H8/300H
Core Size	16-Bit
Speed	20MHz
Connectivity	SCI
Peripherals	PWM, WDT
Number of I/O	30
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 75°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/df36014fpv

Table 18.8	Power-Supply-Voltage Detection Circuit Characteristics.....	266
Table 18.9	Power-On Reset Circuit Characteristics.....	267
Table 18.10	DC Characteristics (1).....	270
Table 18.10	DC Characteristics (2).....	274
Table 18.11	AC Characteristics	275
Table 18.12	Serial Interface (SCI3) Timing	277
Table 18.13	A/D Converter Characteristics	278
Table 18.14	Watchdog Timer Characteristics.....	279
Table 18.15	Power-Supply-Voltage Detection Circuit Characteristics.....	280
Table 18.16	Power-On Reset Circuit Characteristics.....	281

Appendix

Table A.1	Instruction Set.....	287
Table A.2	Operation Code Map (1).....	300
Table A.2	Operation Code Map (2).....	301
Table A.2	Operation Code Map (3).....	302
Table A.3	Number of Cycles in Each Instruction.....	304
Table A.4	Number of Cycles in Each Instruction.....	305
Table A.5	Combinations of Instructions and Addressing Modes	314

2.1 Address Space and Memory Map

The address space of this LSI is 64 kbytes, which includes the program area and the data area. Figures 2.1 show the memory maps.

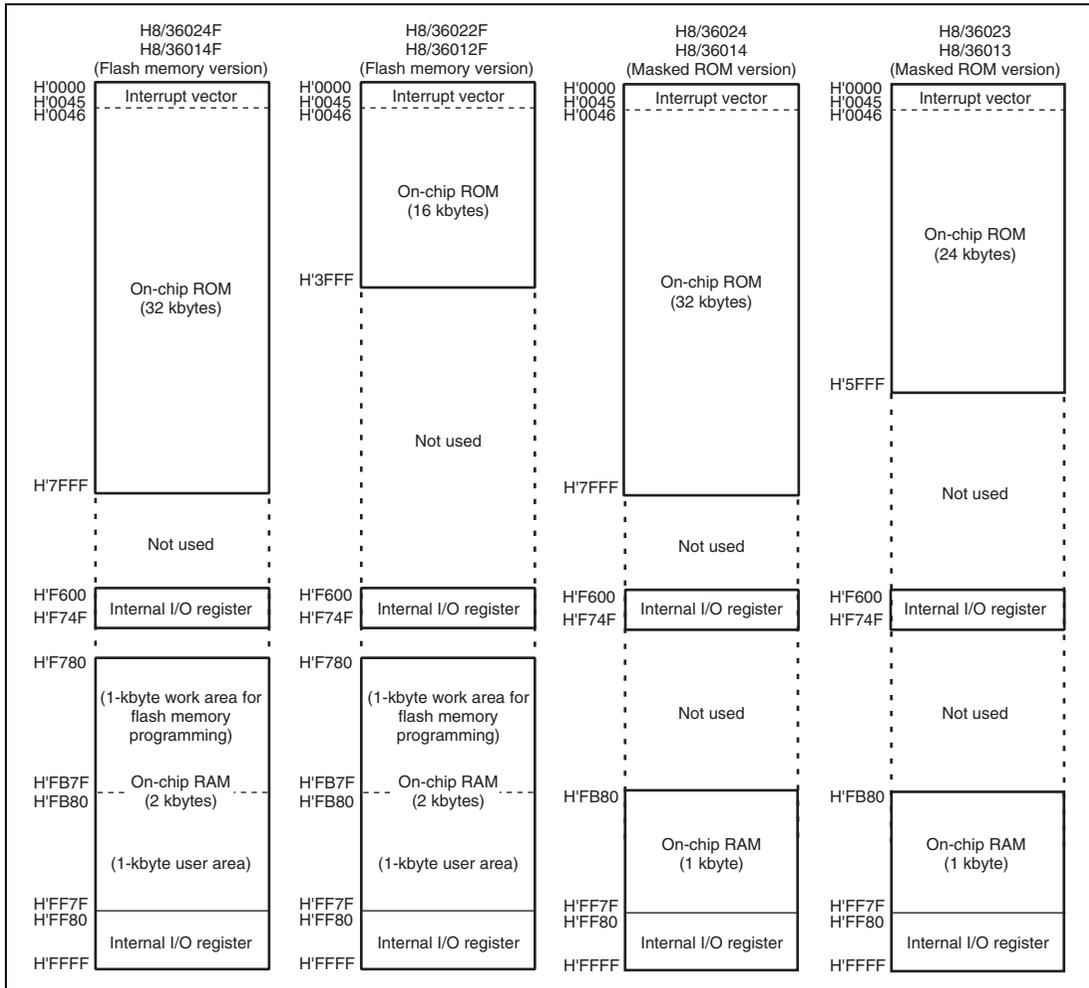


Figure 2.1 Memory Map (1)

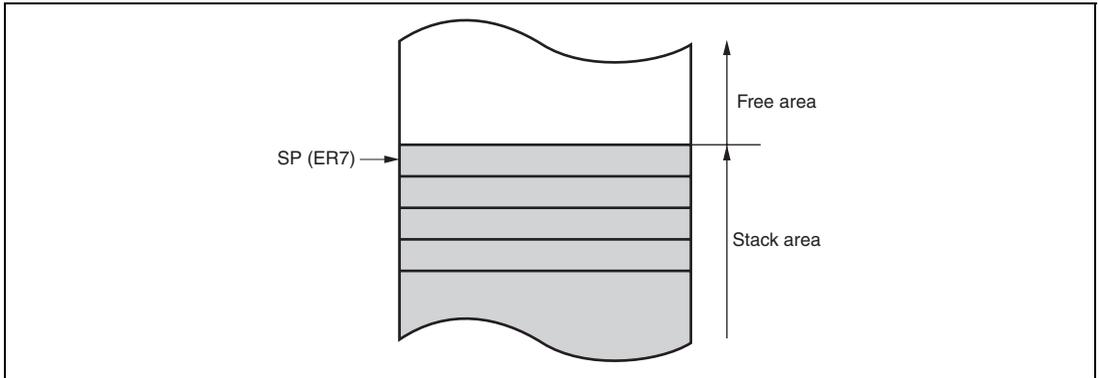


Figure 2.4 Relationship between Stack Pointer and Stack Area

2.2.2 Program Counter (PC)

This 24-bit counter indicates the address of the next instruction the CPU will execute. The length of all CPU instructions is 2 bytes (one word), so the least significant PC bit is ignored. (When an instruction is fetched, the least significant PC bit is regarded as 0). The PC is initialized when the start address is loaded by the vector address generated during reset exception-handling sequence.

2.2.3 Condition-Code Register (CCR)

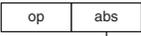
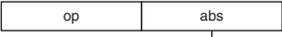
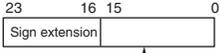
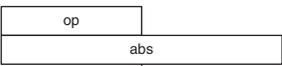
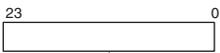
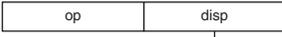
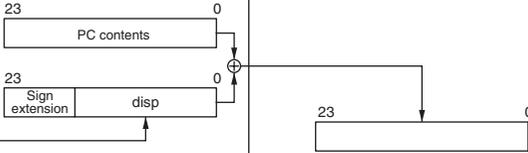
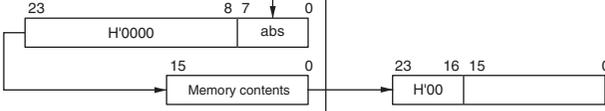
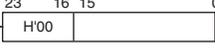
This 8-bit register contains internal CPU status information, including an interrupt mask bit (I) and half-carry (H), negative (N), zero (Z), overflow (V), and carry (C) flags. The I bit is initialized to 1 by reset exception-handling sequence, but other bits are not initialized.

Some instructions leave flag bits unchanged. Operations can be performed on the CCR bits by the LDC, STC, ANDC, ORC, and XORC instructions. The N, Z, V, and C flags are used as branching conditions for conditional branch (Bcc) instructions.

For the action of each instruction on the flag bits, see Appendix A.1, Instruction List.

Bit	Bit Name	Initial Value	R/W	Description
7	I	1	R/W	<p>Interrupt Mask Bit</p> <p>Masks interrupts other than NMI when set to 1. NMI is accepted regardless of the I bit setting. The I bit is set to 1 at the start of an exception-handling sequence.</p>
6	UI	Undefined	R/W	<p>User Bit</p> <p>Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions.</p>
5	H	Undefined	R/W	<p>Half-Carry Flag</p> <p>When the ADD.B, ADDX.B, SUB.B, SUBX.B, CMP.B, or NEG.B instruction is executed, this flag is set to 1 if there is a carry or borrow at bit 3, and cleared to 0 otherwise. When the ADD.W, SUB.W, CMP.W, or NEG.W instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 11, and cleared to 0 otherwise. When the ADD.L, SUB.L, CMP.L, or NEG.L instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 27, and cleared to 0 otherwise.</p>
4	U	Undefined	R/W	<p>User Bit</p> <p>Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions.</p>
3	N	Undefined	R/W	<p>Negative Flag</p> <p>Stores the value of the most significant bit of data as a sign bit.</p>
2	Z	Undefined	R/W	<p>Zero Flag</p> <p>Set to 1 to indicate zero data, and cleared to 0 to indicate non-zero data.</p>
1	V	Undefined	R/W	<p>Overflow Flag</p> <p>Set to 1 when an arithmetic overflow occurs, and cleared to 0 at other times.</p>
0	C	Undefined	R/W	<p>Carry Flag</p> <p>Set to 1 when a carry occurs, and cleared to 0 otherwise. Used by:</p> <ul style="list-style-type: none"> • Add instructions, to indicate a carry • Subtract instructions, to indicate a borrow • Shift and rotate instructions, to indicate a carry <p>The carry flag is also used as a bit accumulator by bit manipulation instructions.</p>

Table 2.12 Effective Address Calculation (2)

No	Addressing Mode and Instruction Format	Effective Address Calculation	Effective Address (EA)
5	Absolute address @aa:8 		
	@aa:16 		
	@aa:24 		
6	Immediate #xx:8/#xx:16/#xx:32 		Operand is immediate data.
7	Program-counter relative @(d:8,PC) @(d:16,PC) 		
8	Memory indirect @aa:8 		

Legend

- r, rm, rn : Register field
- op : Operation field
- disp : Displacement
- IMM : Immediate data
- abs : Absolute address

5.3.2 Notes on Board Design

When using a crystal resonator (ceramic resonator), place the resonator and its load capacitors as close as possible to the OSC_1 and OSC_2 pins. Other signal lines should be routed away from the oscillator circuit to prevent induction from interfering with correct oscillation (see figure 5.7).

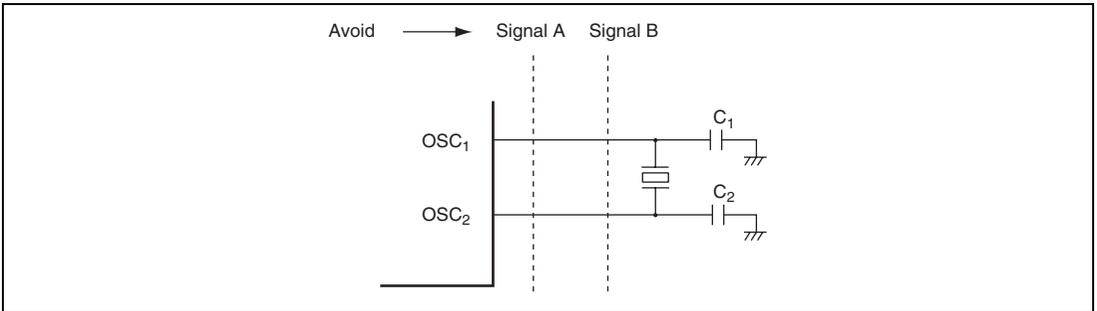


Figure 5.7 Example of Incorrect Board Design

7.3 On-Board Programming Modes

There is a mode for programming/erasing of the flash memory; boot mode, which enables on-board programming/erasing. On-board programming/erasing can also be performed in user program mode. At reset-start in reset mode, this LSI changes to a mode depending on the TEST pin settings, $\overline{\text{NMI}}$ pin settings, and input level of each port, as shown in table 7.1. The input level of each pin must be defined four states before the reset ends.

When changing to boot mode, the boot program built into this LSI is initiated. The boot program transfers the programming control program from the externally-connected host to on-chip RAM via SCI3. After erasing the entire flash memory, the programming control program is executed. This can be used for programming initial values in the on-board state or for a forcible return when programming/erasing can no longer be done in user program mode. In user program mode, individual blocks can be erased and programmed by branching to the user program/erase control program prepared by the user.

Table 7.1 Setting Programming Modes

TEST	$\overline{\text{NMI}}$	E10T_0	PB0	PB1	PB2	LSI State after Reset End
0	1	X	X	X	X	User Mode
0	0	1	X	X	X	Boot Mode

Legend: X: Don't care.

7.3.1 Boot Mode

Table 7.2 shows the boot mode operations between reset end and branching to the programming control program.

1. When boot mode is used, the flash memory programming control program must be prepared in the host beforehand. Prepare a programming control program in accordance with the description in section 7.4, Flash Memory Programming/Erasing.
2. SCI3 should be set to asynchronous mode, and the transfer format as follows: 8-bit data, 1 stop bit, and no parity.
3. When the boot program is initiated, the chip measures the low-level period of asynchronous SCI communication data (H'00) transmitted continuously from the host. The chip then calculates the bit rate of transmission from the host, and adjusts the SCI3 bit rate to match that of the host. The reset should end with the RxD pin high. The RxD and TxD pins should be pulled up on the board if necessary. After the reset is complete, it takes approximately 100 states before the chip is ready to measure the low-level period.

9.5 Port 8

Port 8 is a general I/O port also functioning as a timer W I/O pin. Each pin of the port 8 is shown in figure 9.5. The register setting of the timer W has priority for functions of the pins P84/FTIOD, P83/FTIOC, P82/FTIOB, and P81/FTIOA. The P80/FTCI pin also functions as a timer W input port that is connected to the timer W regardless of the register setting of port 8.

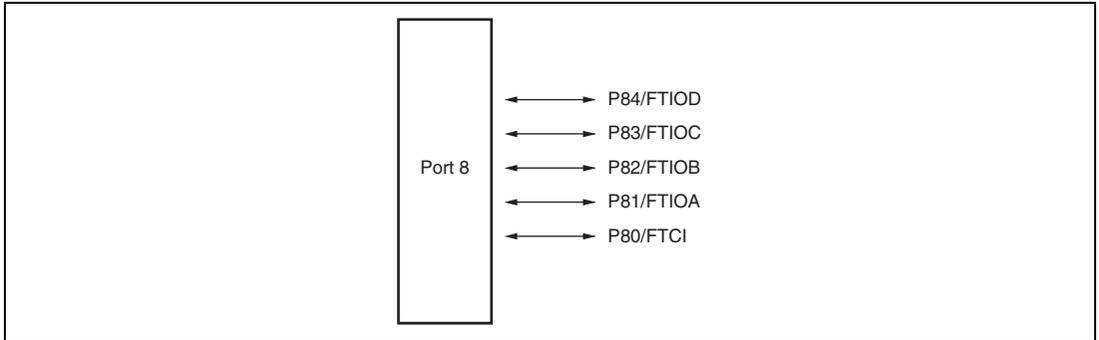


Figure 9.5 Port 8 Pin Configuration

Port 8 has the following registers.

- Port control register 8 (PCR8)
- Port data register 8 (PDR8)

9.5.1 Port Control Register 8 (PCR8)

PCR8 selects inputs/outputs in bit units for pins to be used as general I/O ports of port 8.

Bit	Bit Name	Initial Value	R/W	Description
7 to 5	—	—	—	Reserved
4	PCR84	0	W	When each of the port 8 pins P84 to P80 functions as an general I/O port, setting a PCR8 bit to 1 makes the corresponding pin an output port, while clearing the bit to 0 makes the pin an input port.
3	PCR83	0	W	
2	PCR82	0	W	
1	PCR81	0	W	
0	PCR80	0	W	

10.5.2 Pulse Output with Arbitrary Pulse Width and Delay from TRGV Input

The trigger function can be used to output a pulse with an arbitrary pulse width at an arbitrary delay from the TRGV input, as shown in figure 10.10. To set up this output:

1. Set bits CCLR1 and CCLR0 in TCRV0 so that TCNTV will be cleared by compare match with TCORB.
2. Set bits OS3 to OS0 in TCSR0V so that the output will go to 1 at compare match with TCORA and to 0 at compare match with TCORB.
3. Set bits TVEG1 and TVEG0 in TCRV1 and set TRGE to select the falling edge of the TRGV input.
4. Set bits CKS2 to CKS0 in TCRV0 and bit ICKS0 in TCRV1 to select the desired clock source.
5. After these settings, a pulse waveform will be output without further software intervention, with a delay determined by TCORA from the TRGV input, and a pulse width determined by $(TCORB - TCORA)$.

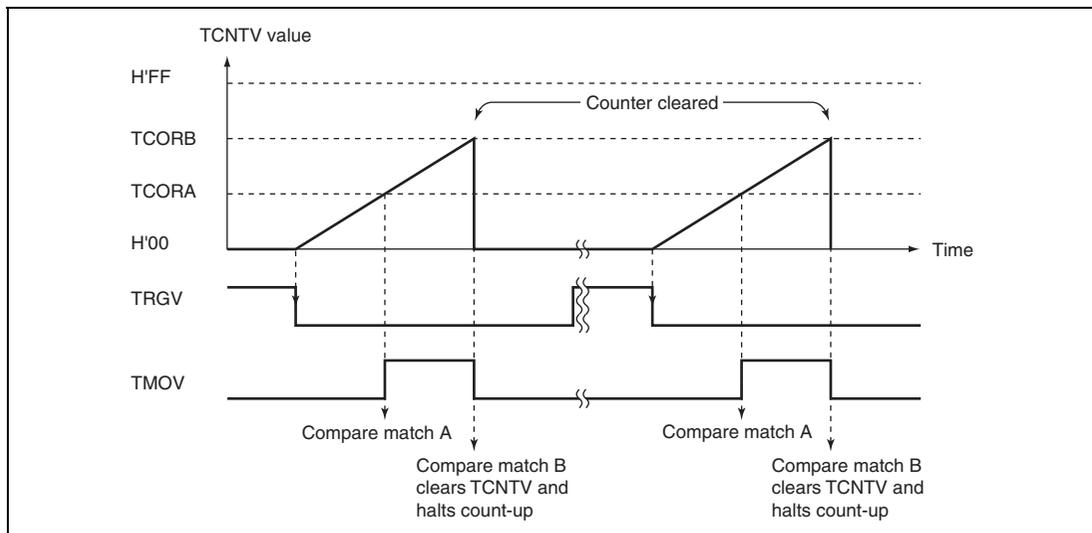


Figure 10.10 Example of Pulse Output Synchronized to TRGV Input

Bit	Bit Name	Initial Value	R/W	Description
1	IMFB	0	R/W	<p>Input Capture/Compare Match Flag B</p> <p>[Setting conditions]</p> <ul style="list-style-type: none"> • TCNT = GRB when GRB functions as an output compare register • The TCNT value is transferred to GRB by an input capture signal when GRB functions as an input capture register <p>[Clearing condition]</p> <p>Read IMFB when IMFB = 1, then write 0 in IMFB</p>
0	IMFA	0	R/W	<p>Input Capture/Compare Match Flag A</p> <p>[Setting conditions]</p> <ul style="list-style-type: none"> • TCNT = GRA when GRA functions as an output compare register • The TCNT value is transferred to GRA by an input capture signal when GRA functions as an input capture register <p>[Clearing condition]</p> <p>Read IMFA when IMFA = 1, then write 0 in IMFA</p>

11.3.5 Timer I/O Control Register 0 (TIOR0)

TIOR0 selects the functions of GRA and GRB, and specifies the functions of the FTIOA and FTIOB pins.

Bit	Bit Name	Initial Value	R/W	Description
7	—	1	—	Reserved This bit is always read as 1.
6	IOB2	0	R/W	I/O Control B2 Selects the GRB function. 0: GRB functions as an output compare register 1: GRB functions as an input capture register
5	IOB1	0	R/W	I/O Control B1 and B0
4	IOB0	0	R/W	When IOB2 = 0, 00: No output at compare match 01: 0 output to the FTIOB pin at GRB compare match 10: 1 output to the FTIOB pin at GRB compare match 11: Output toggles to the FTIOB pin at GRB compare match When IOB2 = 1, 00: Input capture at rising edge at the FTIOB pin 01: Input capture at falling edge at the FTIOB pin 1X: Input capture at rising and falling edges of the FTIOB pin
3	—	1	—	Reserved This bit is always read as 1.
2	IOA2	0	R/W	I/O Control A2 Selects the GRA function. 0: GRA functions as an output compare register 1: GRA functions as an input capture register

Periodic counting operation can be performed when GRA is set as an output compare register and bit CCLR in TCRW is set to 1. When the count matches GRA, TCNT is cleared to H'0000, the IMFA flag in TSRW is set to 1. If the corresponding IMIEA bit in TIERW is set to 1, an interrupt request is generated. TCNT continues counting from H'0000. Figure 11.3 shows periodic counting.

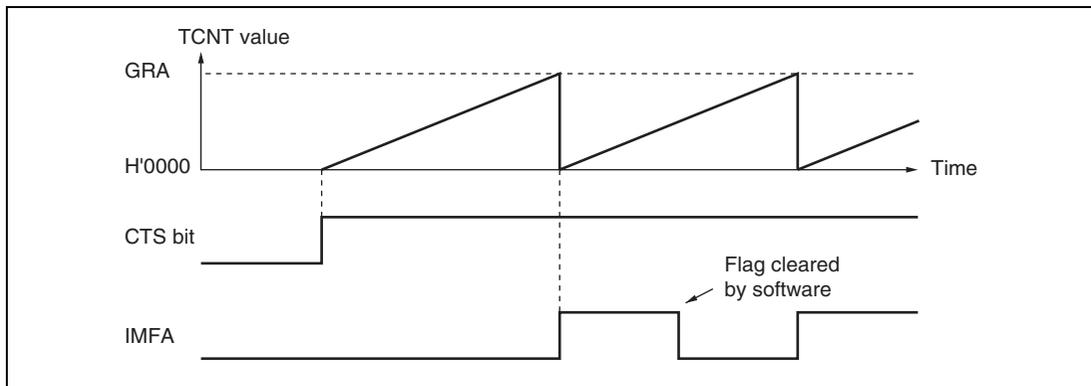


Figure 11.3 Periodic Counter Operation

By setting a general register as an output compare register, compare match A, B, C, or D can cause the output at the FTIOA, FTIOB, FTIOC, or FTIOD pin to output 0, output 1, or toggle. Figure 11.4 shows an example of 0 and 1 output when TCNT operates as a free-running counter, 1 output is selected for compare match A, and 0 output is selected for compare match B. When signal is already at the selected output level, the signal level does not change at compare match.

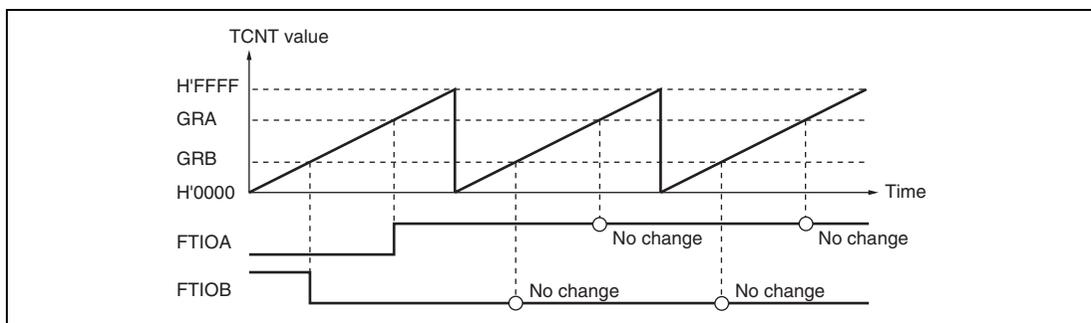


Figure 11.4 0 and 1 Output Example (TOA = 0, TOB = 1)

The TCNT value can be captured into a general register (GRA, GRB, GRC, or GRD) when a signal level changes at an input-capture pin (FTIOA, FTIOB, FTIOC, or FTIOD). Capture can take place on the rising edge, falling edge, or both edges. By using the input-capture function, the pulse width and periods can be measured. Figure 11.7 shows an example of input capture when both edges of FTIOA and the falling edge of FTIOB are selected as capture edges. TCNT operates as a free-running counter.

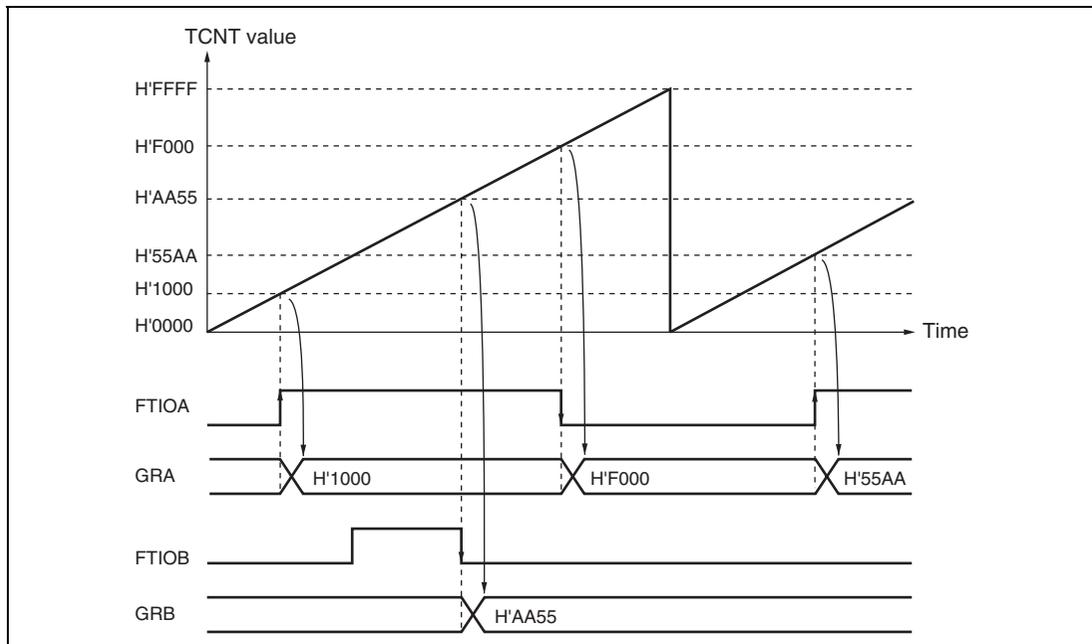


Figure 11.7 Input Capture Operating Example

Figure 11.11 shows an example of buffer operation when the FTIOB pin is set to PWM mode and GRD is set as the buffer register for GRB. TCNT is cleared by compare match A, and FTIOB outputs 1 at compare match B and 0 at compare match A.

Due to the buffer operation, the FTIOB output level changes and the value of buffer register GRD is transferred to GRB whenever compare match B occurs. This procedure is repeated every time compare match B occurs.

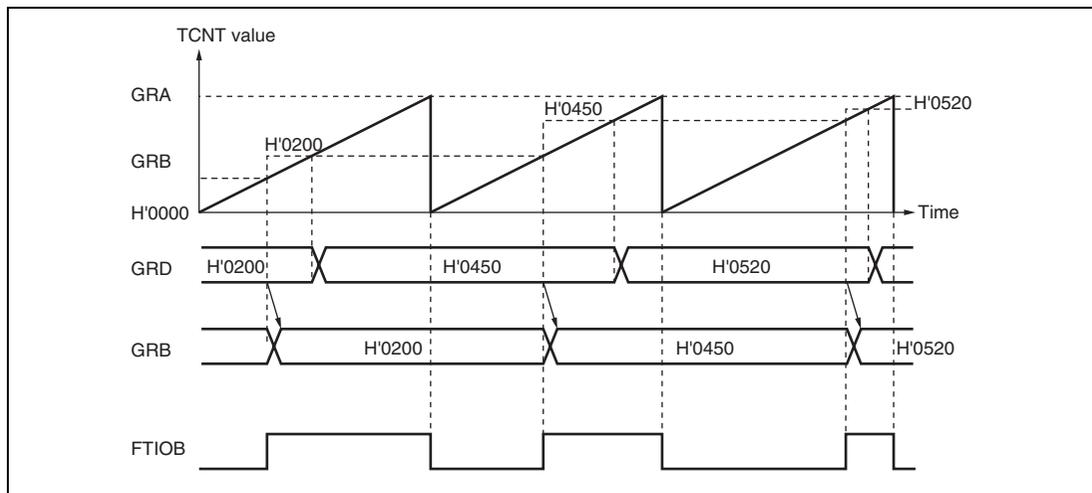


Figure 11.11 Buffer Operation Example (Output Compare)

12.3 Operation

The watchdog timer is provided with an 8-bit counter. If 1 is written to WDON while writing 0 to B2WI when the TCSRWE bit in TCSRWD is set to 1, TCWD begins counting up. (To operate the watchdog timer, two write accesses to TCSRWD are required.) When a clock pulse is input after the TCWD count value has reached H'FF, the watchdog timer overflows and an internal reset signal is generated. The internal reset signal is output for a period of $256 \phi_{osc}$ clock cycles. TCWD is a writable counter, and when a value is set in TCWD, the count-up starts from that value. An overflow period in the range of 1 to 256 input clock cycles can therefore be set, according to the TCWD set value.

Figure 12.2 shows an example of watchdog timer operation.

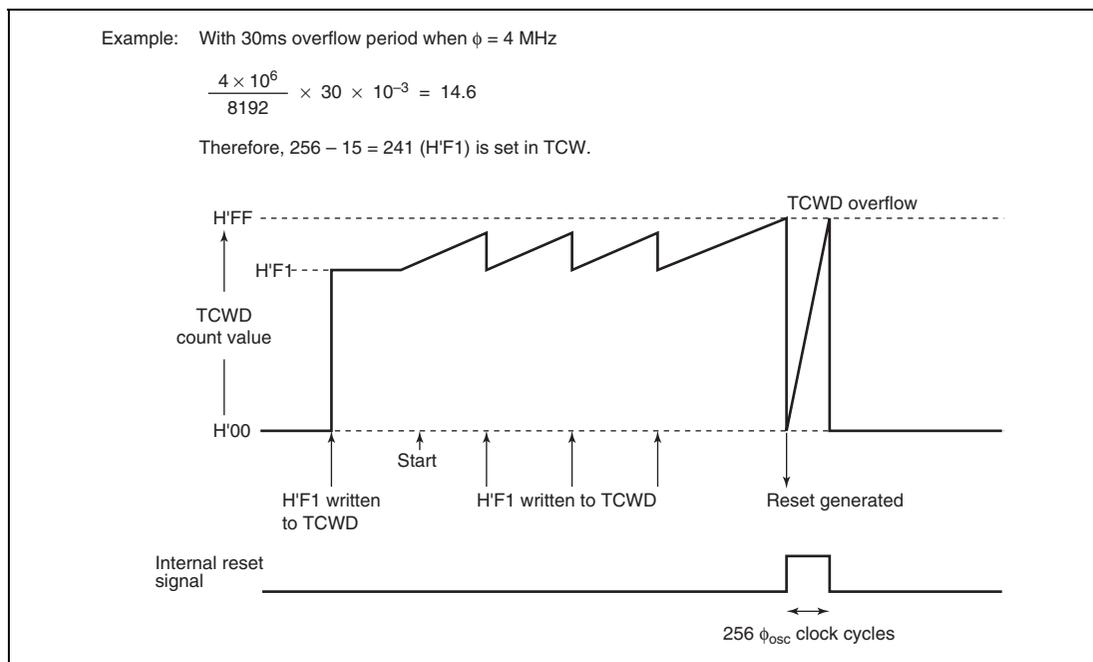


Figure 12.2 Watchdog Timer Operation Example

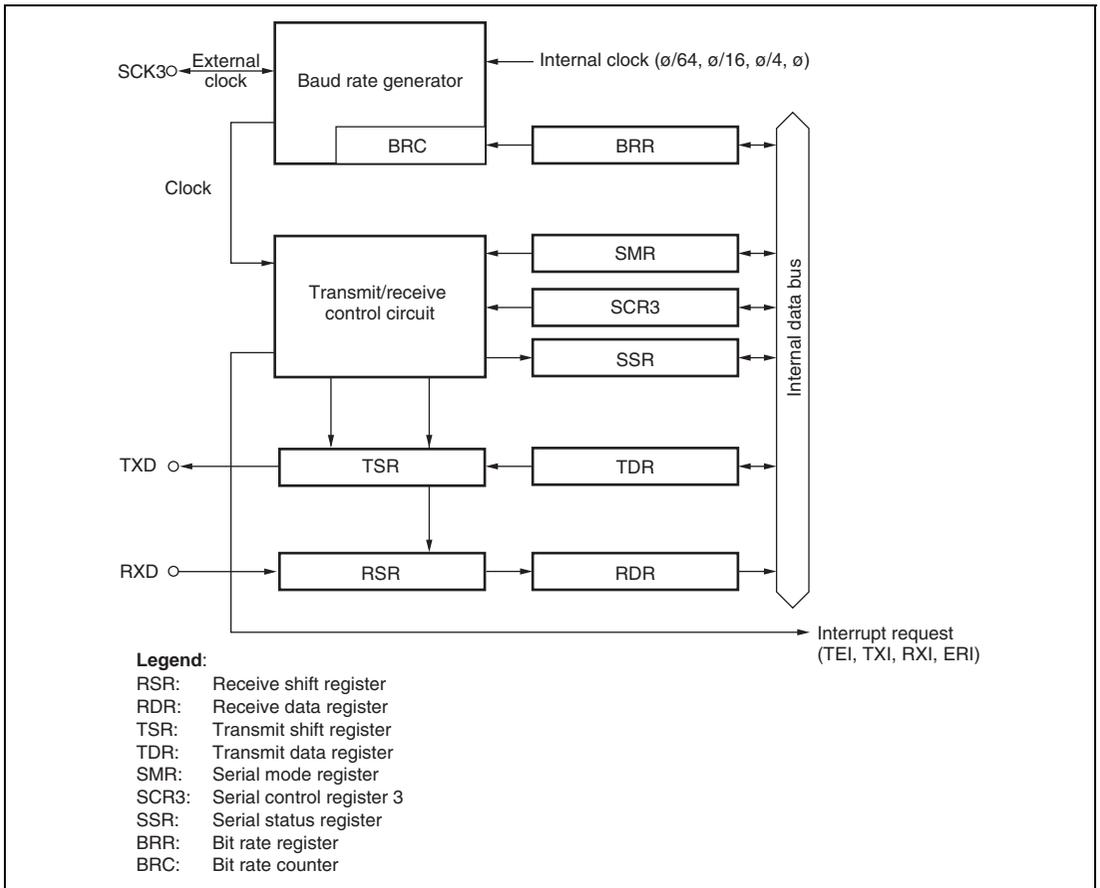


Figure 13.1 Block Diagram of SCI3

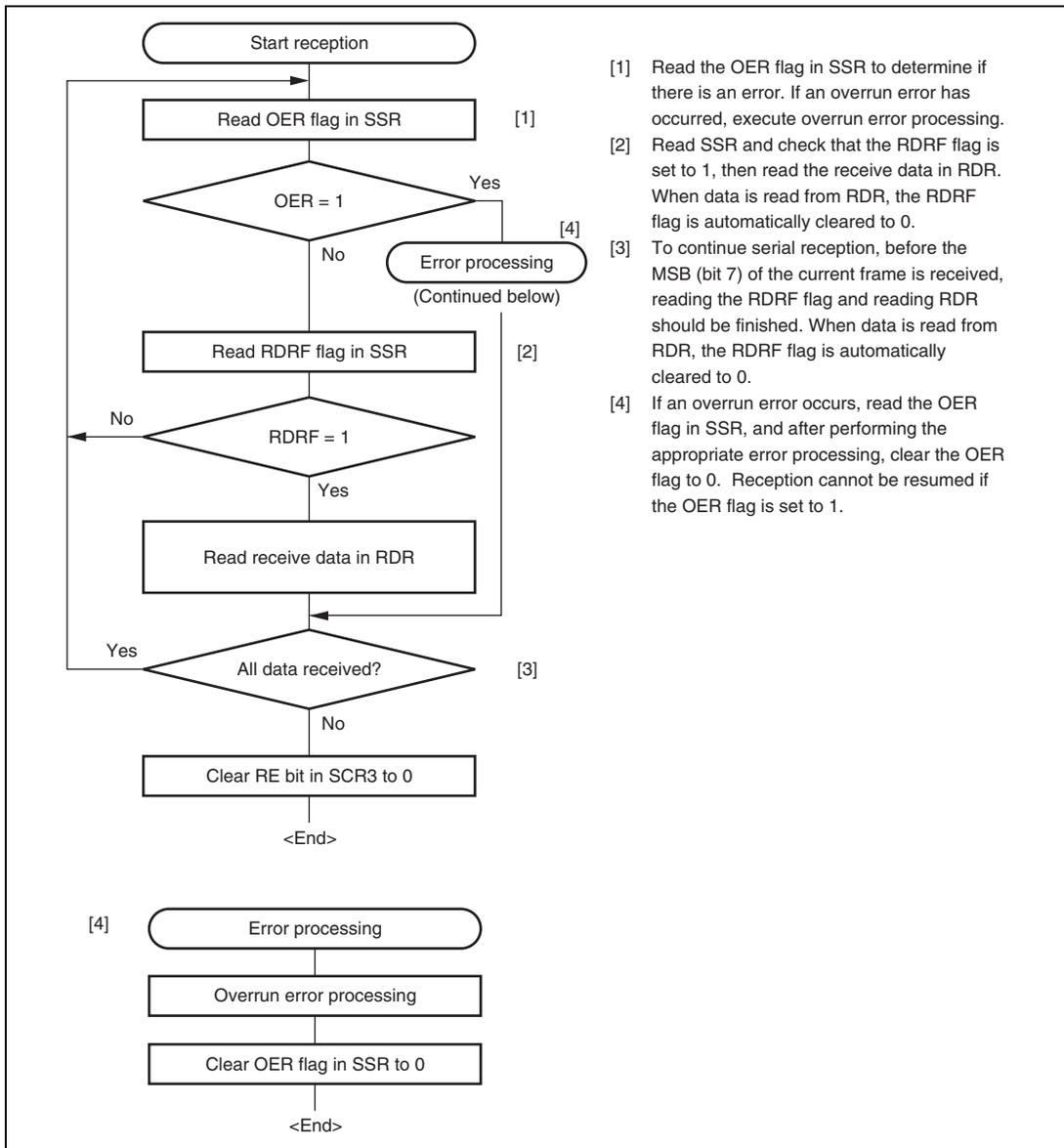


Figure 13.13 Sample Serial Reception Flowchart (Clocked Synchronous Mode)

13.7 Interrupts

SCI3 creates the following six interrupt requests: transmission end, transmit data empty, receive data full, and receive errors (overrun error, framing error, and parity error). Table 13.7 shows the interrupt sources.

Table 13.7 SCI3 Interrupt Requests

Interrupt Requests	Abbreviation	Interrupt Sources
Receive Data Full	RXI	Setting RDRF in SSR
Transmit Data Empty	TXI	Setting TDRE in SSR
Transmission End	TEI	Setting TEND in SSR
Receive Error	ERI	Setting OER, FER, and PER in SSR

The initial value of the TDRE flag in SSR is 1. Thus, when the TIE bit in SCR3 is set to 1 before transferring the transmit data to TDR, a TXI interrupt request is generated even if the transmit data is not ready. The initial value of the TEND flag in SSR is 1. Thus, when the TEIE bit in SCR3 is set to 1 before transferring the transmit data to TDR, a TEI interrupt request is generated even if the transmit data has not been sent. It is possible to make use of the most of these interrupt requests efficiently by transferring the transmit data to TDR in the interrupt routine. To prevent the generation of these interrupt requests (TXI and TEI), set the enable bits (TIE and TEIE) that correspond to these interrupt requests to 1, after transferring the transmit data to TDR.

18.2.6 Flash Memory Characteristics

Table 18.7 Flash Memory Characteristics

$V_{CC} = 3.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0.0\text{ V}$, $T_a = -20^\circ\text{C to }+75^\circ\text{C}$, unless otherwise specified.

Item	Symbol	Test Condition	Values			Unit	
			Min	Typ	Max		
Programming time (per 128 bytes)* ¹ * ² * ⁴	t_P		—	7	200	ms	
Erase time (per block) * ¹ * ³ * ⁵	t_E		—	100	1200	ms	
Reprogramming count	N_{WEC}		1000	10000	—	Times	
Programming	Wait time after SWE bit setting* ¹	x	1	—	—	μs	
	Wait time after PSU bit setting* ¹	y	50	—	—	μs	
	Wait time after P bit setting * ¹ * ⁴	z1	$1 \leq n \leq 6$	28	30	32	μs
		z2	$7 \leq n \leq 1000$	198	200	202	μs
		z3	Additional-programming	8	10	12	μs
	Wait time after P bit clear* ¹	α		5	—	—	μs
	Wait time after PSU bit clear* ¹	β		5	—	—	μs
	Wait time after PV bit setting* ¹	γ		4	—	—	μs
	Wait time after dummy write* ¹	ϵ		2	—	—	μs
	Wait time after PV bit clear* ¹	η		2	—	—	μs
	Wait time after SWE bit clear* ¹	θ		100	—	—	μs
	Maximum programming count* ¹ * ⁴ * ⁵	N		—	—	1000	Times

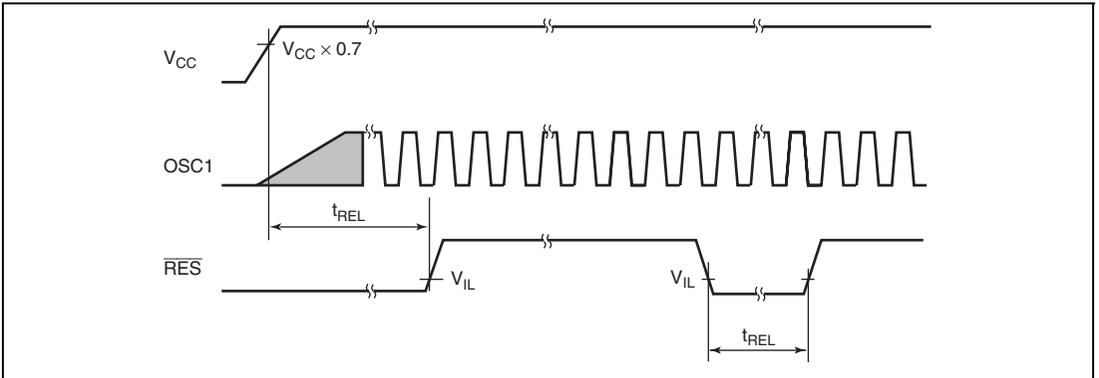


Figure 18.2 $\overline{\text{RES}}$ Low Width Timing

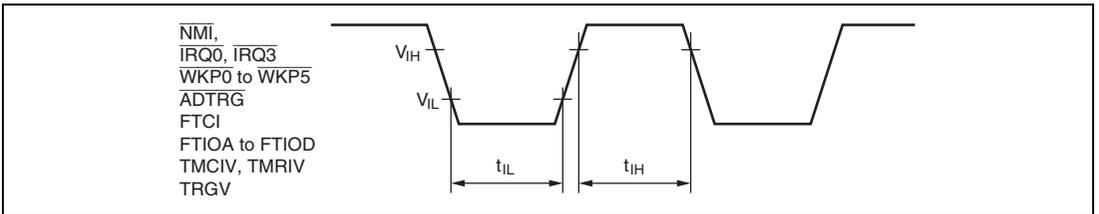


Figure 18.3 Input Timing

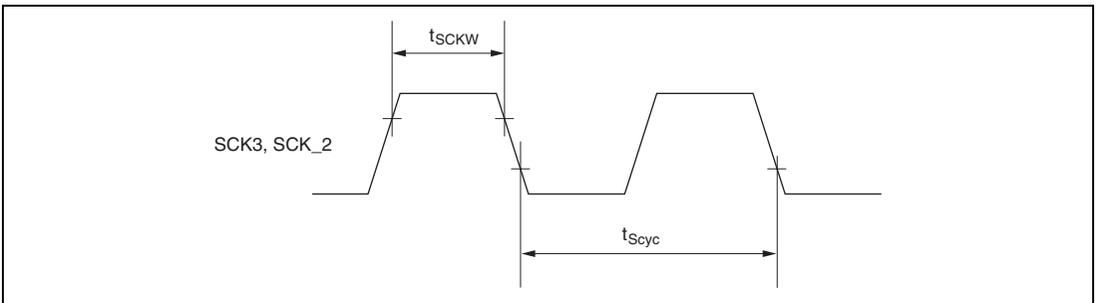


Figure 18.4 SCK3 Input Clock Timing